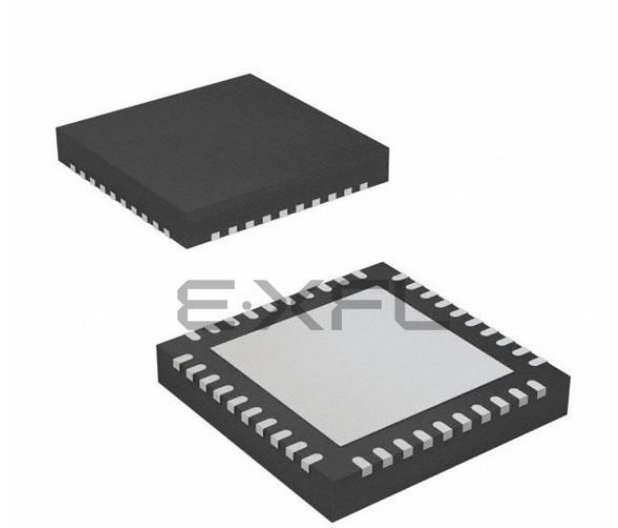

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	8051
Core Size	8-Bit
Speed	50MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	POR, PWM, Temp Sensor, WDT
Number of I/O	33
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.25V
Data Converters	A/D 32x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	40-VFQFN Exposed Pad
Supplier Device Package	40-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f571-imr

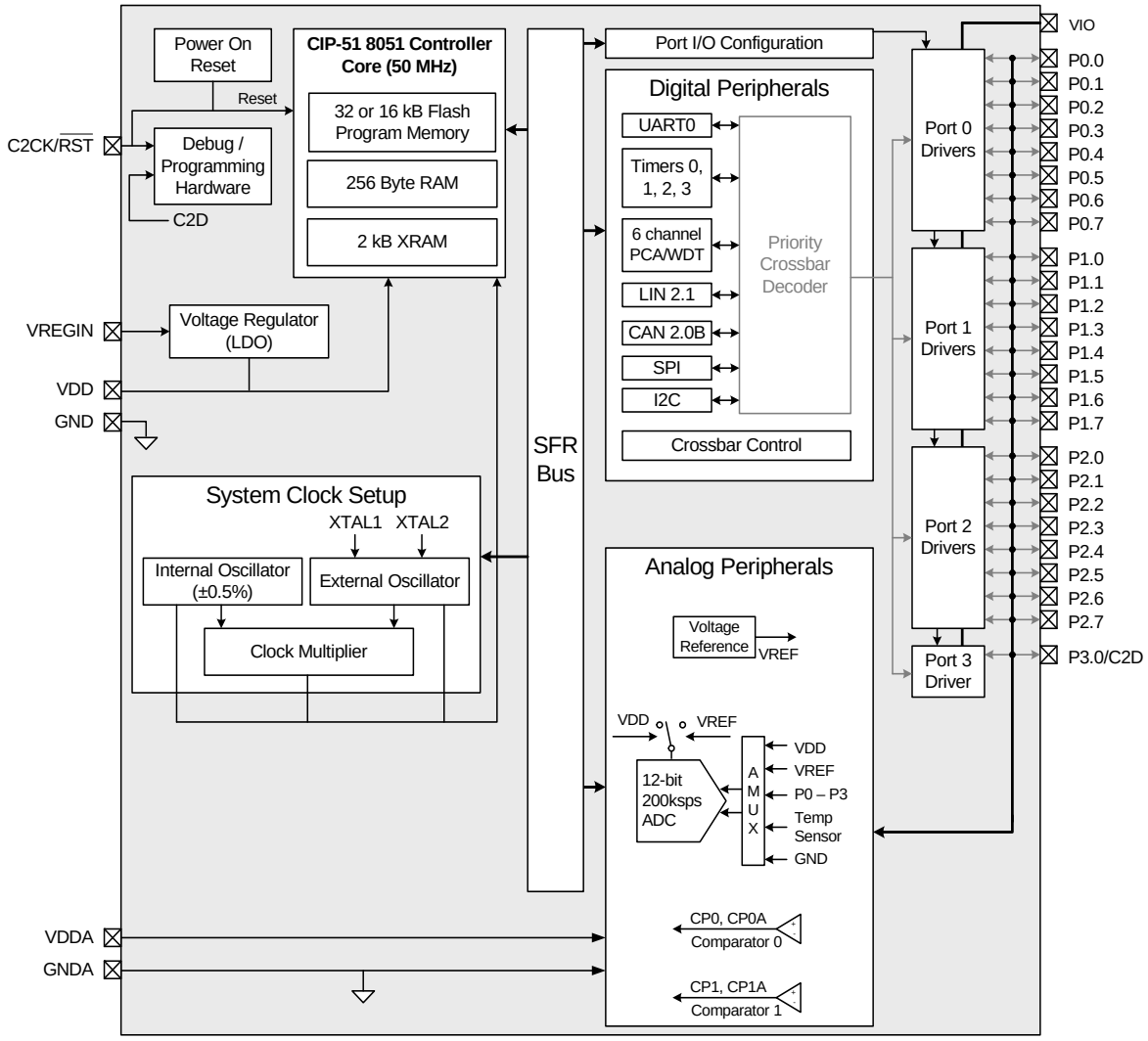

Figure 1.2. C8051F560-7 (32-pin) Block Diagram

SFR Definition 6.7. ADC0CN: ADC0 Control

Bit	7	6	5	4	3	2	1	0
Name	AD0EN	BURSTEN	AD0INT	AD0BUSY	AD0WINT	AD0LJST	AD0CM[1:0]	
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE8; SFR Page = 0x00; Bit-Addressable

Bit	Name	Function		
7	AD0EN	**ADC0 Enable Bit.** 0: ADC0 Disabled. ADC0 is in low-power shutdown. 1: ADC0 Enabled. ADC0 is active and ready for data conversions.		
6	BURSTEN	**ADC0 Burst Mode Enable Bit.** 0: Burst Mode Disabled. 1: Burst Mode Enabled.		
5	AD0INT	**ADC0 Conversion Complete Interrupt Flag.** 0: ADC0 has not completed a data conversion since AD0INT was last cleared. 1: ADC0 has completed a data conversion.		
4	AD0BUSY	**ADC0 Busy Bit.**	**Read:** 0: ADC0 conversion is not in progress. 1: ADC0 conversion is in progress.	**Write:** 0: No Effect. 1: Initiates ADC0 Conversion if AD0CM[1:0] = 00b
3	AD0WINT	**ADC0 Window Compare Interrupt Flag.** This bit must be cleared by software 0: ADC0 Window Comparison Data match has not occurred since this flag was last cleared. 1: ADC0 Window Comparison Data match has occurred.		
2	AD0LJST	**ADC0 Left Justify Select Bit.** 0: Data in ADC0H:ADC0L registers is right-justified 1: Data in ADC0H:ADC0L registers is left-justified. This option should not be used with a repeat count greater than 1 (when AD0RPT[1:0] is 01b, 10b, or 11b).		
1:0	AD0CM[1:0]	**ADC0 Start of Conversion Mode Select.** 00: ADC0 start-of-conversion source is write of 1 to AD0BUSY. 01: ADC0 start-of-conversion source is overflow of Timer 1. 10: ADC0 start-of-conversion source is rising edge of external CNVSTR. 11: ADC0 start-of-conversion source is overflow of Timer 2.		

7. Voltage Reference

The Voltage reference multiplexer on the C8051F55x/56x/57x devices is configurable to use an externally connected voltage reference, the on-chip reference voltage generator routed to the VREF pin, or the V_{DD} power supply voltage (see Figure 7.1). The REFSL bit in the Reference Control register (REF0CN, SFR Definition 7.1) selects the reference source for the ADC. For an external source or the on-chip reference, REFSL should be set to 0 to select the VREF pin. To use V_{DD} as the reference source, REFSL should be set to 1.

The BIASE bit enables the internal voltage bias generator, which is used by the ADC, Temperature Sensor, and internal oscillator. This bias is automatically enabled when any peripheral which requires it is enabled, and it does not need to be enabled manually. The bias generator may be enabled manually by writing a 1 to the BIASE bit in register REF0CN. The electrical specifications for the voltage reference circuit are given in Table 5.11.

The on-chip voltage reference circuit consists of a temperature stable bandgap voltage reference generator and a gain-of-two output buffer amplifier. The output voltage is selectable between 1.5 V and 2.25 V. The on-chip voltage reference can be driven on the VREF pin by setting the REFBE bit in register REF0CN to a 1. The maximum load seen by the VREF pin must be less than 200 µA to GND. Bypass capacitors of 0.1 µF and 4.7 µF are recommended from the VREF pin to GND. If the on-chip reference is not used, the REFBE bit should be cleared to 0. Electrical specifications for the on-chip voltage reference are given in Table 5.11.

Important Note about the VREF Pin: When using either an external voltage reference or the on-chip reference circuitry, the VREF pin should be configured as an analog pin and skipped by the Digital Crossbar. Refer to Section “19. Port Input/Output” on page 169 for the location of the VREF pin, as well as details of how to configure the pin in analog mode and to be skipped by the crossbar. If VDD is selected as the voltage reference in the REF0CN register and the ADC is enabled in the ADC0CN register, the P0.0/VREF pin cannot operate as a general purpose I/O pin in open-drain mode. With the above settings, this pin can operate in push-pull output mode or as an analog input.

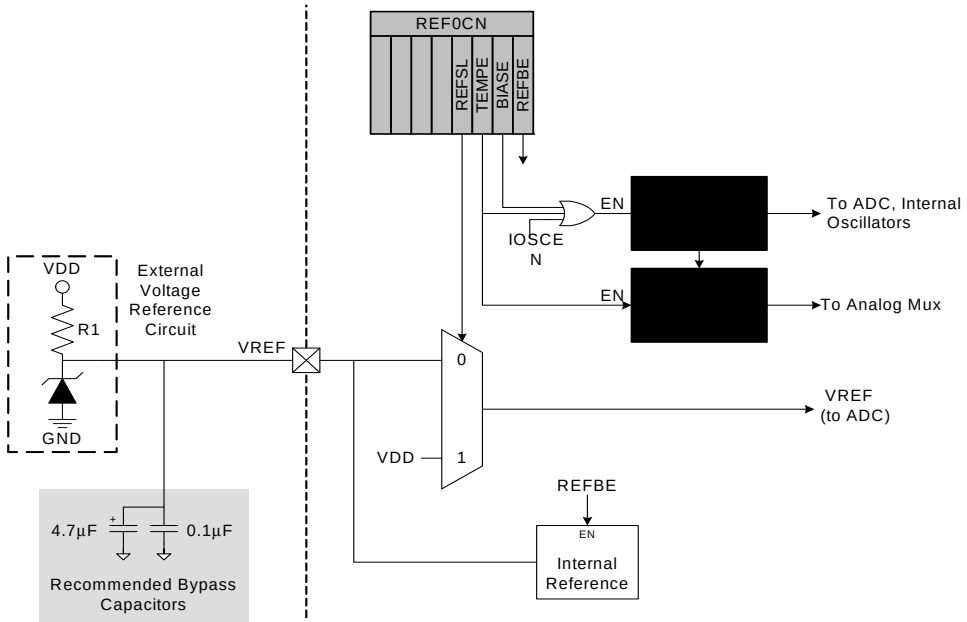

Figure 7.1. Voltage Reference Functional Block Diagram

While in the CAN0 ISR, a PCA interrupt occurs. Recall the PCA interrupt is configured as a high priority interrupt, while the CAN0 interrupt is configured as a *low* priority interrupt. Thus, the CIP-51 will now vector to the high priority PCA ISR. Upon doing so, the CIP-51 will automatically place the SFR page needed to access the PCA's special function registers into the SFRPAGE register, SFR Page 0x00. The value that was in the SFRPAGE register before the PCA interrupt (SFR Page 0x0C for CAN0) is pushed down the stack into SFRNEXT. Likewise, the value that was in the SFRNEXT register before the PCA interrupt (in this case SFR Page 0x00 for SPI0DAT) is pushed down to the SFRLAST register, the "bottom" of the stack. Note that a value stored in SFRLAST (via a previous software write to the SFRLAST register) will be overwritten. See Figure 12.4.

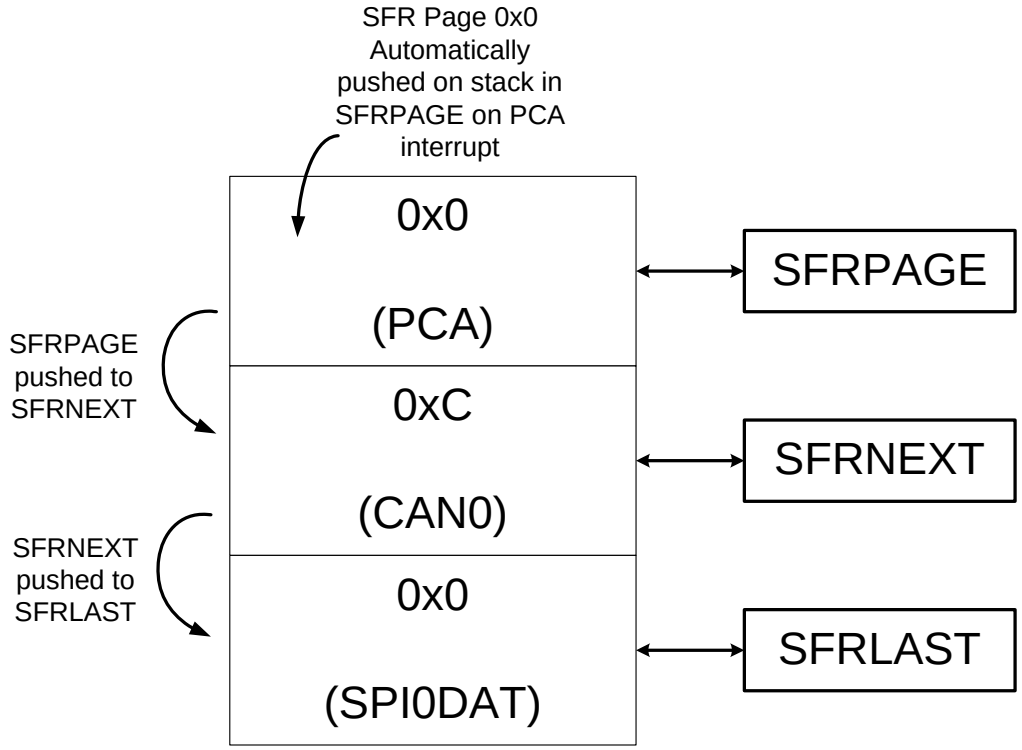

Figure 12.4. SFR Page Stack Upon PCA Interrupt Occurring During a CAN0 ISR

Table 12.3. Special Function Registers (Continued)

SFRs are listed in alphabetical order. All undefined SFR locations are reserved

Register	Address	Description	Page
IT01CF	0xE4	INT0/INT1 Configuration	123
LIN0ADR	0xD3	LIN0 Address	200
LIN0CF	0xC9	LIN0 Configuration	200
LIN0DAT	0xD2	LIN0 Data	201
OSCICN	0xA1	Internal Oscillator Control	160
OSCICRS	0xA2	Internal Oscillator Coarse Control	161
OSCIFIN	0x9E	Internal Oscillator Fine Calibration	161
OSCXCN	0x9F	External Oscillator Control	165
P0	0x80	Port 0 Latch	183
P0MASK	0xF2	Port 0 Mask Configuration	179
P0MAT	0xF1	Port 0 Match Configuration	179
P0MDIN	0xF1	Port 0 Input Mode Configuration	184
P0MDOUT	0xA4	Port 0 Output Mode Configuration	184
P0SKIP	0xD4	Port 0 Skip	185
P1	0x90	Port 1 Latch	185
P1MASK	0xF4	Port 1 Mask Configuration	180
P1MAT	0xF3	Port 1 Match Configuration	180
P1MDIN	0xF2	Port 1 Input Mode Configuration	186
P1MDOUT	0xA5	Port 1 Output Mode Configuration	186
P1SKIP	0xD5	Port 1 Skip	187
P2	0xA0	Port 2 Latch	187
P2MASK	0xB2	Port 2 Mask Configuration	181
P2MAT	0xB1	Port 2 Match Configuration	181
P2MDIN	0xF3	Port 2 Input Mode Configuration	188
P2MDOUT	0xA6	Port 2 Output Mode Configuration	188
P2SKIP	0xD6	Port 2 Skip	189
P3	0xB0	Port 3 Latch	189
P3MASK	0xAF	Port 3 Mask Configuration	182
P3MAT	0xAE	Port 3 Match Configuration	182
P3MDIN	0xF4	Port 3 Input Mode Configuration	190
P3MDOUT	0xAE	Port 3 Output Mode Configuration	190
P3SKIP	0xD7	Port 3 Skip	191
P4	0xB5	Port 4 Latch	191
P4MDOUT	0xAF	Port 4 Output Mode Configuration	192
PCA0CN	0xD8	PCA Control	294
PCA0CPH0	0xFC	PCA Capture 0 High	299

SFR Definition 13.7. IT01CF: INT0/INT1 Configuration

Bit	7	6	5	4	3	2	1	0
Name	IN1PL	IN1SL[2:0]			IN0PL	IN0SL[2:0]		
Type	R/W	R/W			R/W	R/W		
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xE4; SFR Page = 0x0F

Bit	Name	Function
7	IN1PL	**$\overline{\text{INT1}}$ Polarity.** 0: $\overline{\text{INT1}}$ input is active low. 1: $\overline{\text{INT1}}$ input is active high.
6:4	IN1SL[2:0]	**$\overline{\text{INT1}}$ Port Pin Selection Bits.** These bits select which Port pin is assigned to $\overline{\text{INT1}}$. Note that this pin assignment is independent of the Crossbar; $\overline{\text{INT1}}$ will monitor the assigned Port pin without disturbing the peripheral that has been assigned the Port pin via the Crossbar. The Crossbar will not assign the Port pin to a peripheral if it is configured to skip the selected pin. 000: Select P1.0 001: Select P1.1 010: Select P1.2 011: Select P1.3 100: Select P1.4 101: Select P1.5 110: Select P1.6 111: Select P1.7
3	IN0PL	**$\overline{\text{INT0}}$ Polarity.** 0: $\overline{\text{INT0}}$ input is active low. 1: $\overline{\text{INT0}}$ input is active high.
2:0	IN0SL[2:0]	**$\overline{\text{INT0}}$ Port Pin Selection Bits.** These bits select which Port pin is assigned to $\overline{\text{INT0}}$. Note that this pin assignment is independent of the Crossbar; $\overline{\text{INT0}}$ will monitor the assigned Port pin without disturbing the peripheral that has been assigned the Port pin via the Crossbar. The Crossbar will not assign the Port pin to a peripheral if it is configured to skip the selected pin. 000: Select P1.0 001: Select P1.1 010: Select P1.2 011: Select P1.3 100: Select P1.4 101: Select P1.5 110: Select P1.6 111: Select P1.7

14. Flash Memory

On-chip, re-programmable Flash memory is included for program code and non-volatile data storage. The Flash memory can be programmed in-system, a single byte at a time, through the C2 interface or by software using the MOVX instruction. Once cleared to logic 0, a Flash bit must be erased to set it back to logic 1. Flash bytes would typically be erased (set to 0xFF) before being reprogrammed. The write and erase operations are automatically timed by hardware for proper execution; data polling to determine the end of the write/erase operation is not required. Code execution is stalled during a Flash write/erase operation. Refer to Table 5.5 for complete Flash memory electrical characteristics.

14.1. Programming The Flash Memory

The simplest means of programming the Flash memory is through the C2 interface using programming tools provided by Silicon Labs or a third party vendor. This is the only means for programming a non-initialized device. For details on the C2 commands to program Flash memory, see Section “27. C2 Interface” on page 300.

To ensure the integrity of Flash contents, it is strongly recommended that the on-chip V_{DD} Monitor be enabled in any system that includes code that writes and/or erases Flash memory from software. See Section 14.4 for more details. Before performing any Flash write or erase procedure, set the FLEWT bit in Flash Scale register (FLSCL) to 1. Also, note that 8-bit MOVX instructions cannot be used to erase or write to Flash memory at addresses higher than 0x00FF.

For –I (Industrial Grade) parts, parts programmed at a cold temperature below 0 °C may exhibit weakly programmed flash memory bits. If programmed at 0 °C or higher, there is no problem reading Flash across the entire temperature range of -40 °C to 125 °C. This temperature restriction does not apply to –A (Automotive Grade) devices.

14.1.1. Flash Lock and Key Functions

Flash writes and erases by user software are protected with a lock and key function. The Flash Lock and Key Register (FLKEY) must be written with the correct key codes, in sequence, before Flash operations may be performed. The key codes are: 0xA5, 0xF1. The timing does not matter, but the codes must be written in order. If the key codes are written out of order, or the wrong codes are written, Flash writes and erases will be disabled until the next system reset. Flash writes and erases will also be disabled if a Flash write or erase is attempted before the key codes have been written properly. The Flash lock resets after each write or erase; the key codes must be written again before a following Flash operation can be performed. The FLKEY register is detailed in SFR Definition 14.2.

SFR Definition 14.2. FLKEY: Flash Lock and Key

Bit	7	6	5	4	3	2	1	0
Name	FLKEY[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xB7; SFR Page = All Pages

Bit	Name	Function
7:0	FLKEY[7:0]	**Flash Lock and Key Register.** Write: This register provides a lock and key function for Flash erasures and writes. Flash writes and erases are enabled by writing 0xA5 followed by 0xF1 to the FLKEY register. Flash writes and erases are automatically disabled after the next write or erase is complete. If any writes to FLKEY are performed incorrectly, or if a Flash write or erase operation is attempted while these operations are disabled, the Flash will be permanently locked from writes or erasures until the next device reset. If an application never writes to Flash, it can intentionally lock the Flash by writing a non-0xA5 value to FLKEY from software. Read: When read, bits 1–0 indicate the current Flash lock state. 00: Flash is write/erase locked. 01: The first key code has been written (0xA5). 10: Flash is unlocked (writes/erases allowed). 11: Flash writes/erases disabled until the next reset.

SFR Definition 14.4. CCH0CN: Cache Control

Bit	7	6	5	4	3	2	1	0
Name	Reserved	Reserved	CHPFEN	Reserved	Reserved	Reserved	Reserved	CHBLKW
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	1	0	0	0	0	0

SFR Address = 0xE3; SFR Page = 0x0F

Bit	Name	Function
7:6	Reserved	Must Write 00b
5	CHPFEN	**Cache Prefect Enable Bit.** 0: Prefetch engine is disabled. 1: Prefetch engine is enabled.
4:1	Reserved	Must Write 0000b.
0	CHBLKW	**Block Write Enable Bit.** This bit allows block writes to Flash memory from firmware. 0: Each byte of a software Flash write is written individually. 1: Flash bytes are written in groups of two.

SFR Definition 14.5. ONESHOT: Flash Oneshot Period

Bit	7	6	5	4	3	2	1	0
Name					PERIOD[3:0]			
Type	R	R	R	R	R/W	R/W	R/W	R/W
Reset	0	0	0	0	1	1	1	1

SFR Address = 0xBE; SFR Page = 0x0F

Bit	Name	Function
7:4	Unused	Read = 0000b. Write = don't care.
3:0	PERIOD[3:0]	**Oneshot Period Control Bits.** These bits limit the internal Flash read strobe width as follows. When the Flash read strobe is de-asserted, the Flash memory enters a low-power state for the remainder of the system clock cycle. $FLASH_{RDMAX} = 5ns + (PERIOD \times 5ns)$

SFR Definition 19.13. P0MDIN: Port 0 Input Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDIN[7:0]							
Type	R/W							
Reset	1	1	1	1	1	1	1	1

SFR Address = 0xF1; SFR Page = 0x0F

Bit	Name	Function
7:0	P0MDIN[7:0]	**Analog Configuration Bits for P0.7–P0.0 (respectively).** Port pins configured for analog mode have their weak pull-up and digital receiver disabled. For analog mode, the pin also needs to be configured for open-drain mode in the P0MDOUT register. 0: Corresponding P0.n pin is configured for analog mode. 1: Corresponding P0.n pin is not configured for analog mode.

SFR Definition 19.14. P0MDOUT: Port 0 Output Mode

Bit	7	6	5	4	3	2	1	0
Name	P0MDOUT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xA4; SFR Page = 0x0F

Bit	Name	Function
7:0	P0MDOUT[7:0]	**Output Configuration Bits for P0.7–P0.0 (respectively).** These bits are ignored if the corresponding bit in register P0MDIN is logic 0. 0: Corresponding P0.n Output is open-drain. 1: Corresponding P0.n Output is push-pull.

Table 22.1. SMBus Clock Source Selection

SMBCS1	SMBCS0	SMBus Clock Source
0	0	Timer 0 Overflow
0	1	Timer 1 Overflow
1	0	Timer 2 High Byte Overflow
1	1	Timer 2 Low Byte Overflow

The SMBCS1–0 bits select the SMBus clock source, which is used only when operating as a master or when the Free Timeout detection is enabled. When operating as a master, overflows from the selected source determine the absolute minimum SCL low and high times as defined in Equation 22.1. Note that the selected clock source may be shared by other peripherals so long as the timer is left running at all times. For example, Timer 1 overflows may generate the SMBus and UART baud rates simultaneously. Timer configuration is covered in Section “25. Timers” on page 259.

$$T_{HighMin} = T_{LowMin} = \frac{1}{f_{ClockSourceOverflow}}$$

Equation 22.1. Minimum SCL High and Low Times

The selected clock source should be configured to establish the minimum SCL High and Low times as per Equation 22.1. When the interface is operating as a master (and SCL is not driven or extended by any other devices on the bus), the typical SMBus bit rate is approximated by Equation 22.2.

$$BitRate = \frac{f_{ClockSourceOverflow}}{3}$$

Equation 22.2. Typical SMBus Bit Rate

Figure 22.4 shows the typical SCL generation described by Equation 22.2. Notice that T_{HIGH} is typically twice as large as T_{LOW}. The actual SCL output may vary due to other devices on the bus (SCL may be extended low by slower slave devices, or driven low by contending master devices). The bit rate when operating as a master will never exceed the limits defined by equation Equation 22.1.

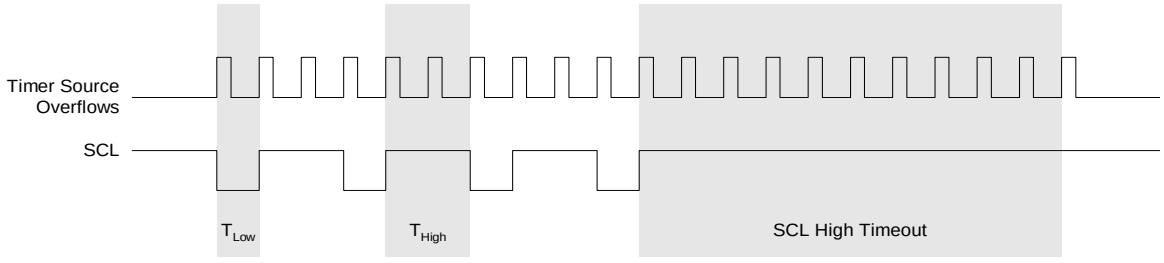

Figure 22.4. Typical SMBus SCL Generation

Table 22.3. Sources for Hardware Changes to SMB0CN

Bit	Set by Hardware When:	Cleared by Hardware When:
MASTER	■ A START is generated.	■ A STOP is generated. ■ Arbitration is lost.
TXMODE	■ START is generated. ■ SMB0DAT is written before the start of an SMBus frame.	■ A START is detected. ■ Arbitration is lost. ■ SMB0DAT is not written before the start of an SMBus frame.
STA	■ A START followed by an address byte is received.	■ Must be cleared by software.
STO	■ A STOP is detected while addressed as a slave. ■ Arbitration is lost due to a detected STOP.	■ A pending STOP is generated.
ACKRQ	■ A byte has been received and an ACK response value is needed.	■ After each ACK cycle.
ARBLOST	■ A repeated START is detected as a MASTER when STA is low (unwanted repeated START). ■ SCL is sensed low while attempting to generate a STOP or repeated START condition. ■ SDA is sensed low while transmitting a 1 (excluding ACK bits).	■ Each time SI is cleared.
ACK	■ The incoming ACK value is low (ACKNOWLEDGE).	■ The incoming ACK value is high (NOT ACKNOWLEDGE).
SI	■ A START has been generated. ■ Lost arbitration. ■ A byte has been transmitted and an ACK/NACK received. ■ A byte has been received. ■ A START or repeated START followed by a slave address + R/W has been received. ■ A STOP has been received.	■ Must be cleared by software.

22.5.2. Read Sequence (Master)

During a read sequence, an SMBus master reads data from a slave device. The master in this transfer will be a transmitter during the address byte, and a receiver during all data bytes. The SMBus interface generates the START condition and transmits the first byte containing the address of the target slave and the data direction bit. In this case the data direction bit (R/W) will be logic 1 (READ). Serial data is then received from the slave on SDA while the SMBus outputs the serial clock. The slave transmits one or more bytes of serial data. An interrupt is generated after each received byte.

Software must write the ACK bit at that time to ACK or NACK the received byte. Writing a 1 to the ACK bit generates an ACK; writing a 0 generates a NACK. Software should write a 0 to the ACK bit for the last data transfer, to transmit a NACK. The interface exits Master Receiver Mode after the STO bit is set and a STOP is generated. The interface will switch to Master Transmitter Mode if SMB0DAT is written while an active Master Receiver. Figure 22.6 shows a typical master read sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur **before** the ACK cycle in this mode.

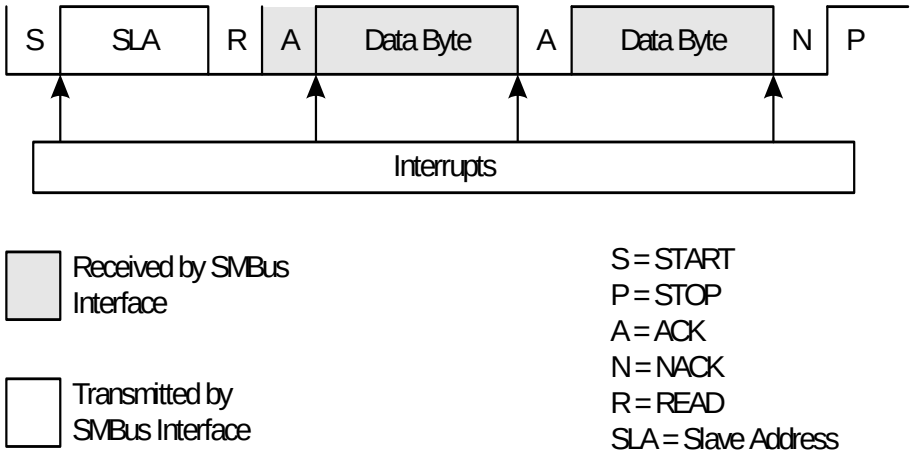

Figure 22.6. Typical Master Read Sequence

22.5.3. Write Sequence (Slave)

During a write sequence, an SMBus master writes data to a slave device. The slave in this transfer will be a receiver during the address byte, and a receiver during all data bytes. When slave events are enabled (INH = 0), the interface enters Slave Receiver Mode when a START followed by a slave address and direction bit (WRITE in this case) is received. Upon entering Slave Receiver Mode, an interrupt is generated and the ACKRQ bit is set. The software must respond to the received slave address with an ACK, or ignore the received slave address with a NACK.

If the received slave address is ignored, slave interrupts will be inhibited until the next START is detected. If the received slave address is acknowledged, zero or more data bytes are received. Software must write the ACK bit at that time to ACK or NACK the received byte.

The interface exits Slave Receiver Mode after receiving a STOP. Note that the interface will switch to Slave Transmitter Mode if SMB0DAT is written while an active Slave Receiver. Figure 22.7 shows a typical slave write sequence. Two received data bytes are shown, though any number of bytes may be received. Notice that the ‘data byte transferred’ interrupts occur **before** the ACK in this mode.

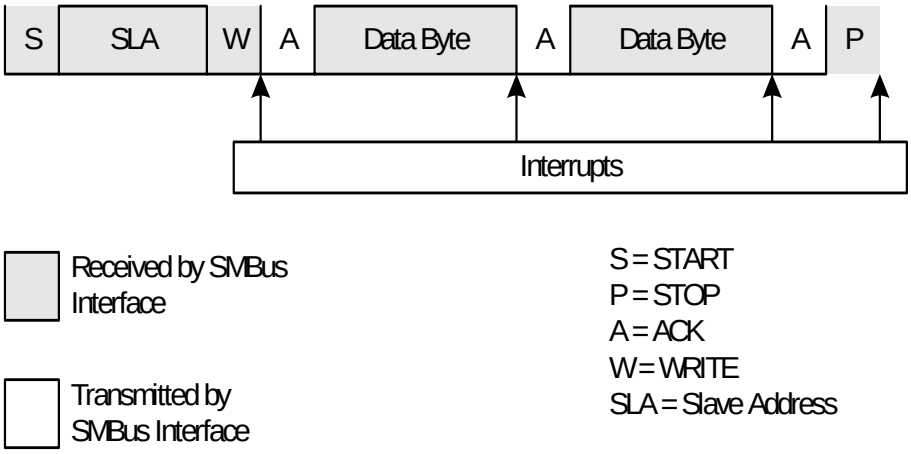

Figure 22.7. Typical Slave Write Sequence

SFR Definition 23.5. SBRLH0: UART0 Baud Rate Generator Reload High Byte

Bit	7	6	5	4	3	2	1	0
Name	SBRLH0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAD; SFR Page = 0x0F

Bit	Name	Function
7:0	SBRLH0[7:0]	**High Byte of Reload Value for UART0 Baud Rate Generator.** This value is loaded into the high byte of the UART0 baud rate generator when the counter overflows from 0xFFFF to 0x0000.

SFR Definition 23.6. SBRLL0: UART0 Baud Rate Generator Reload Low Byte

Bit	7	6	5	4	3	2	1	0
Name	SBRLL0[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

SFR Address = 0xAC; SFR Page = 0x0F

Bit	Name	Function
7:0	SBRLL0[7:0]	**Low Byte of Reload Value for UART0 Baud Rate Generator.** This value is loaded into the low byte of the UART0 baud rate generator when the counter overflows from 0xFFFF to 0x0000.

26.1. PCA Counter/Timer

The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H into a “snapshot” register; the following PCA0H read accesses this “snapshot” register. **Reading the PCA0L Register first guarantees an accurate reading of the entire 16-bit PCA0 counter.** Reading PCA0H or PCA0L does not disturb the counter operation. The CPS[2:0] bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 26.1.

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the CPU is in Idle mode.

Table 26.1. PCA Timebase Input Options

CPS2	CPS1	CPS0	Timebase
0	0	0	System clock divided by 12.
0	0	1	System clock divided by 4.
0	1	0	Timer 0 overflow.
0	1	1	High-to-low transitions on ECI (max rate = system clock divided by 4).
1	0	0	System clock.
1	0	1	External oscillator source divided by 8.*
1	1	x	Reserved.
***Note:** External oscillator source divided by 8 is synchronized with the system clock.			

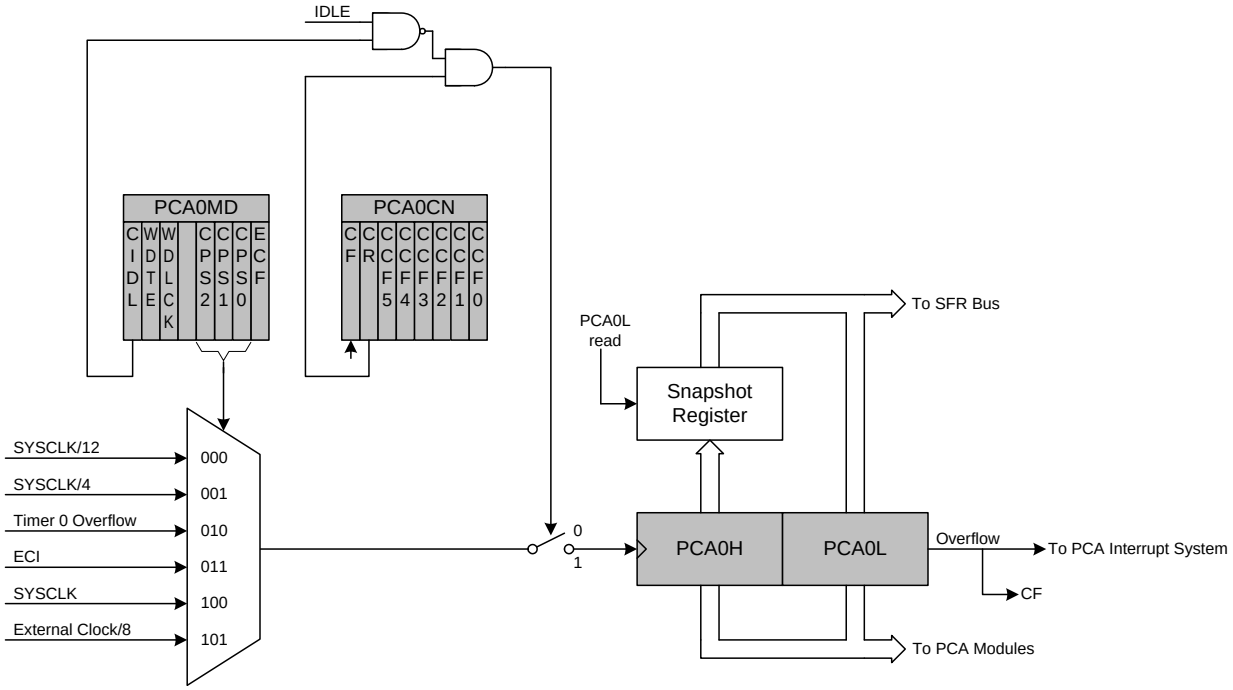

Figure 26.2. PCA Counter/Timer Block Diagram

SFR Definition 26.4. PCA0CPMn: PCA Capture/Compare Mode

Bit	7	6	5	4	3	2	1	0
Name	PWM16n	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn
Type	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

SFR Addresses: PCA0CPM0 = 0xDA, PCA0CPM1 = 0xDB, PCA0CPM2 = 0xDC; PCA0CPM3 = 0xDD, PCA0CPM4 = 0xDE, PCA0CPM5 = 0xDF, SFR Page (all registers) = 0x00

Bit	Name	Function
7	PWM16n	**16-bit Pulse Width Modulation Enable.** This bit enables 16-bit mode when Pulse Width Modulation mode is enabled. 0: 8 to 11-bit PWM selected. 1: 16-bit PWM selected.
6	ECOMn	**Comparator Function Enable.** This bit enables the comparator function for PCA module n when set to 1.
5	CAPPn	**Capture Positive Function Enable.** This bit enables the positive edge capture for PCA module n when set to 1.
4	CAPNn	**Capture Negative Function Enable.** This bit enables the negative edge capture for PCA module n when set to 1.
3	MATn	**Match Function Enable.** This bit enables the match function for PCA module n when set to 1. When enabled, matches of the PCA counter with a module's capture/compare register cause the CCFn bit in PCA0MD register to be set to logic 1.
2	TOGn	**Toggle Function Enable.** This bit enables the toggle function for PCA module n when set to 1. When enabled, matches of the PCA counter with a module's capture/compare register cause the logic level on the CEXn pin to toggle. If the PWMn bit is also set to logic 1, the module operates in Frequency Output Mode.
1	PWMn	**Pulse Width Modulation Mode Enable.** This bit enables the PWM function for PCA module n when set to 1. When enabled, a pulse width modulated signal is output on the CEXn pin. 8 to 11-bit PWM is used if PWM16n is cleared; 16-bit mode is used if PWM16n is set to logic 1. If the TOGn bit is also set, the module operates in Frequency Output Mode.
0	ECCFn	**Capture/Compare Flag Interrupt Enable.** This bit sets the masking of the Capture/Compare Flag (CCFn) interrupt. 0: Disable CCFn interrupts. 1: Enable a Capture/Compare Flag interrupt request when CCFn is set.
Note: When the WDTE bit is set to 1, the PCA0CPM5 register cannot be modified, and module 5 acts as the watchdog timer. To change the contents of the PCA0CPM5 register or the function of module 5, the Watchdog Timer must be disabled.		

C2 Register Definition 27.4. FPCTL: C2 Flash Programming Control

Bit	7	6	5	4	3	2	1	0
Name	FPCTL[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0x02

Bit	Name	Function
7:0	FPCTL[7:0]	**Flash Programming Control Register.** This register is used to enable Flash programming via the C2 interface. To enable C2 Flash programming, the following codes must be written in order: 0x02, 0x01. Note that once C2 Flash programming is enabled, a system reset must be issued to resume normal operation.

C2 Register Definition 27.5. FPDAT: C2 Flash Programming Data

Bit	7	6	5	4	3	2	1	0
Name	FPDAT[7:0]							
Type	R/W							
Reset	0	0	0	0	0	0	0	0

C2 Address: 0xB4

Bit	Name	Function	
7:0	FPDAT[7:0]	**C2 Flash Programming Data Register.** This register is used to pass Flash commands, addresses, and data during C2 Flash accesses. Valid commands are listed below.	
		Code	**Command**
		0x06	Flash Block Read
		0x07	Flash Block Write
		0x08	Flash Page Erase
		0x03	Device Erase

DOCUMENT CHANGE LIST

Revision 0.5 to Revision 1.0

- Updated “2. Ordering Information” to include -A (Automotive) devices and automotive qualification information.
- Updated Figure 4.8 on page 35.
- Updated supply current related specifications throughout “5. Electrical Characteristics” .
- Updated SFR Definition 7.1 to change VREF high setting to 2.20 V from 2.25 V.
- Updated Figure 8.1 to indicate that Comparators are powered from V_{IO} and not V_{DDA}.
- Updated the Gain Table in “6.3.1. Calculating the Gain Value” to fix the ADC0GNH Value in the last row.
- Updated Table 10.1 with correct timing for all branch instructions, MOVC, and CPL A.
- Updated “14.2. Non-volatile Data Storage” to clarify behavior of 8-bit MOVX instructions and when writing/erasing Flash.
- Updated SFR Definition 14.3 (FLSCL) to include FLEWT bit definition. This bit must be set before writing or erasing Flash. Also updated Table 5.5 to reflect new Flash Write and Erase timing.
- Updated “16.7. Flash Error Reset” with an additional cause of a Flash Error reset.
- Updated “19.1.3. Interfacing Port I/O in a Multi-Voltage System” to remove note regarding interfacing to voltages above VIO.
- Updated “22. SMBus” to remove all hardware ACK features, including SMB0ADM and SMB0ADR SFRs.
- Updated SFR Definition 23.1 (SCON0) to correct SFR Page to 0x00 from All Pages.
- All items from the C8051F55x-F56x-57x Errata dated November 5th, 2009 are incorporated into this data sheet.

Revision 1.0 to Revision 1.1

- Updated “1. System Overview” with a voltage range specification for the internal oscillator.
- Updated Table 5.6, “Internal High-Frequency Oscillator Electrical Characteristics,” on page 42 with new conditions for the internal oscillator accuracy. The internal oscillator accuracy is dependent on the operating voltage range.
- Updated “5. Electrical Characteristics” to remove the internal oscillator curve across temperature diagram.
- Updated Figure 6.4 on Page 51 with new timing diagram when using CNVSTR pin.
- Updated SFR Definition 7.1 (REF0CN) with oscillator suspend requirement for ZTCEN.
- Fixed incorrect cross references in “8. Comparators” .
- Updated SFR Definition 9.1 (REG0CN) with a new definition for Bit 6. The bit 6 reset value is 1b and must be written to 1b.
- Update “15.3. Suspend Mode” with note regarding ZTCEN.
- Added Port 2 Event and Port 3 Events to wake-up sources in “18.2.1. Internal Oscillator Suspend Mode”
- Updated “20. Local Interconnect Network (LIN0)” with a voltage range specification for the internal oscillator.
- Updated LIN Register Definitions 20.9 and 20.10 with correct reset values.
- Updated “21. Controller Area Network (CAN0)” with a voltage range specification for the internal oscillator.
- Updated C2 Register Definitions 27.2 and 27.3 with correct C2 and SFR Addresses.